## **APPLICATION DATA SHEET**

Electronic Version v14

Stylesheet Version v14.0

Title of Invention

DOUBLE-SIDED MULTI-CHIP CIRCUIT COMPONENT

Application Type: regular, utility

Attorney Docket Number: DP-310085

Correspondence address:

Customer Number: 27127

Continuing Data:

This is a Continuation-in-part of US application number 10/050,344, filed 2002-01-16, now Pending.

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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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